

Primax

Synonymous with function and performance, enter the Primax, the new era of high intensity illumination in LED. With its high flux output and high luminous intensity, Primax transcends today LED lightings technology and how we perceive it. The small package outline and high intensity make it an ideal choice for backlighting, signage, exterior automotive lighting and decorative lighting.



Features:

- > Super high brightness surface mount LED
- > 120° viewing angle.
- > Compact package outline (LxW) of 3.7 x 3.5 mm.
- > Ultra low height profile - 0.8mm.
- > Low thermal resistance.
- > Compatible to IR reflow soldering.
- > Superior corrosion resistant.
- > Environmental friendly; RoHS compliance.
- > Compliance to automotive standard; AEC-Q102.



Applications:

- > Lighting: Garden light, architecture lighting, signage, etc.
- > Automotive: Interior application, eg: Ambient lighting.
- > Automotive: Exterior application, eg: Welcome lighting.

Optical Characteristics at Tj=25°C

Part Number	Color	Viewing Angle°	Luminous Flux @ 150mA (lm) <i>Appx. 1.2</i>		
			Min.	Typ.	Max.
● MAB-EZHG-H3K2-2	Blue, 455nm	120	5.50	7.15	9.35
● MAB-EZHG-JK3-3	Blue, 460nm	120	6.30	8.20	10.70
● MAB-EZHG-HK2-1	Blue, 457nm	120	4.90	6.30	9.35
● Not for new design					

Electrical Characteristics at Tj=25°C

Part Number	Vf @ If=150mA <i>Appx. 3.1</i>		
	Min. (V)	Typ. (V)	Max. (V)
MAB-EZHG	2.80	3.10	3.40

Absolute Maximum Ratings

	Maximum Value	Unit
DC forward current	250	mA
Peak pulse current (Ts=55°C, tp<=100µs , Duty cycle=0.03)	300	mA
Reverse Voltage	Not designed for reverse bias	V
ESD threshold (HBM)	8	kV
LED junction temperature	150	°C
Operating temperature	-40 ... +125	°C
Storage temperature	-40 ... +125	°C
Thermal resistance (Rated current = 150mA, Ts=25 °C)		
- Real Thermal Resistance		
Junction / solder point, Rth JS real (Typ = 17K/W)	32	K/W
- Electrical Thermal Resistance		
Junction / solder point, Rth JS el (Typ = 10K/W)	19	K/W

Wavelength Grouping at Tj=25°C

Color	Group	Wavelength distribution (nm) <i>Appx. 2.2</i>
MAB; Blue	Full	450 - 465
	A	450 - 455
	B	455 - 460
	C	460 - 465

Luminous Flux at Tj=25°C

Brightness Group	Luminous Flux @ If=150mA (lm) <i>Appx. 1.2</i>
H2	4.90 ... 5.50
H3	5.50 ... 6.30
J2	6.30 ... 7.15
J3	7.15 ... 8.20
K2	8.20 ... 9.35
K3	9.35 ... 10.70

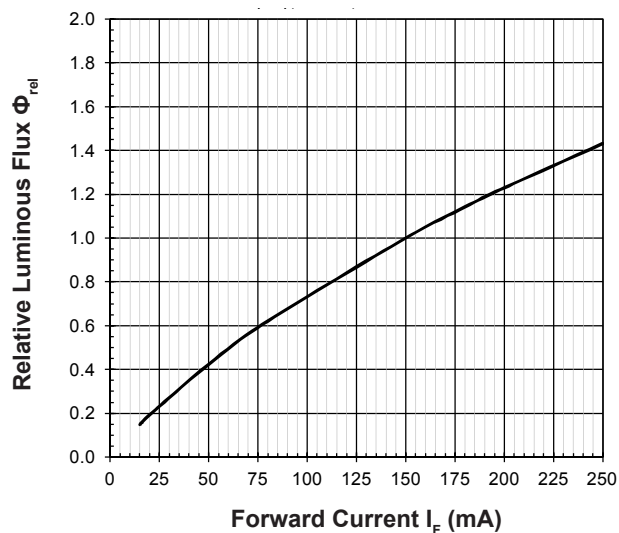
Vf Binning (Optional)

Vf Bin @ 150mA	Forward Voltage (V) <i>Appx. 3.1</i>
VR7	2.80 ... 3.10
VR8	3.10 ... 3.40

Please consult sales and marketing for special part number to incorporate Vf binning.

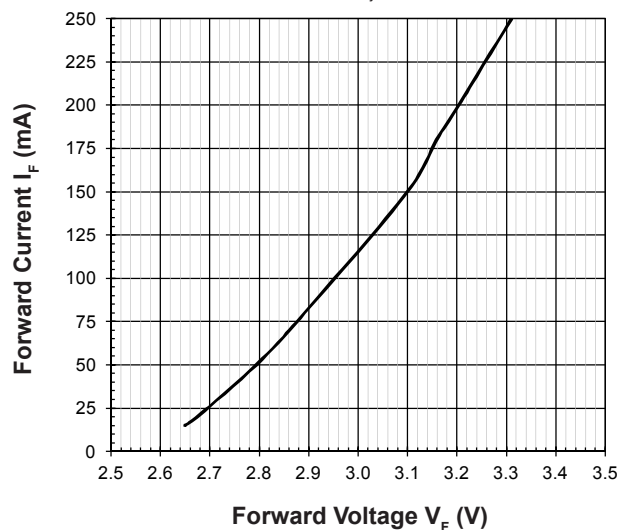
Relative Luminous Flux Vs Forward Current

$$\Phi_V/\Phi_V(150\text{mA}) = f(I_F); T_j = 25^\circ\text{C}$$



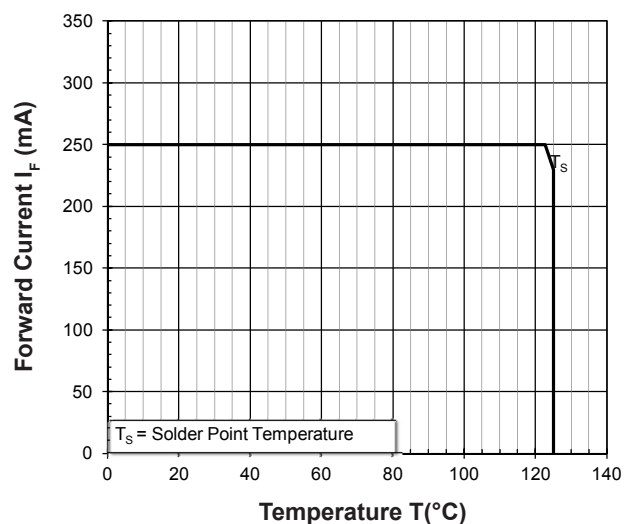
Forward Current Vs Forward Voltage

$$I_F = f(V_F); T_j = 25^\circ\text{C}$$



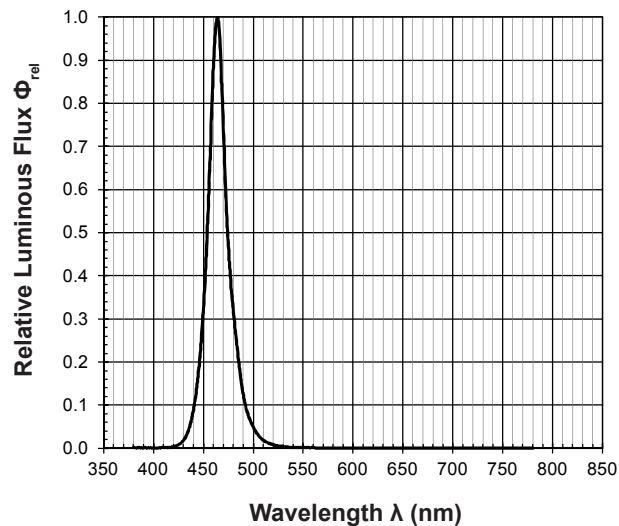
Maximum Current Vs Temperature

$$I_F = f(T)$$



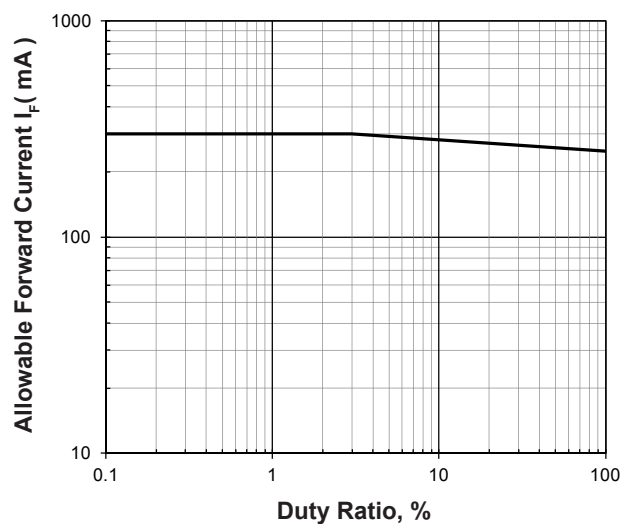
Relative Spectral Emission

$$\Phi_{rel} = f(\lambda); T_j = 25^\circ\text{C}; I_F = 150\text{mA}$$

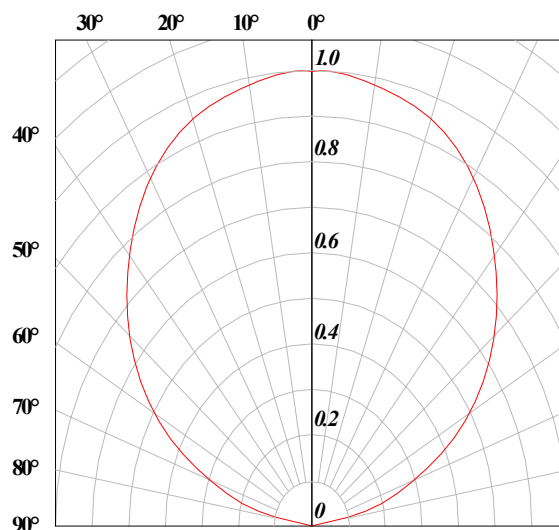


Allowable Forward Current Vs Duty Ratio

$$(T_s = 55^\circ\text{C}; t_p = 100\mu\text{s})$$

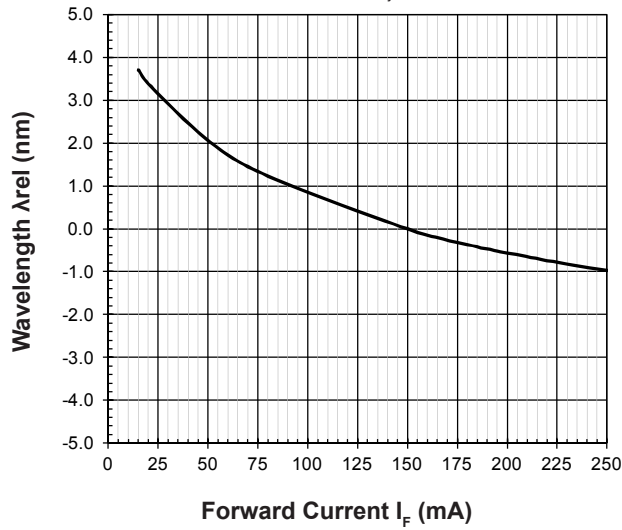


Radiation Pattern



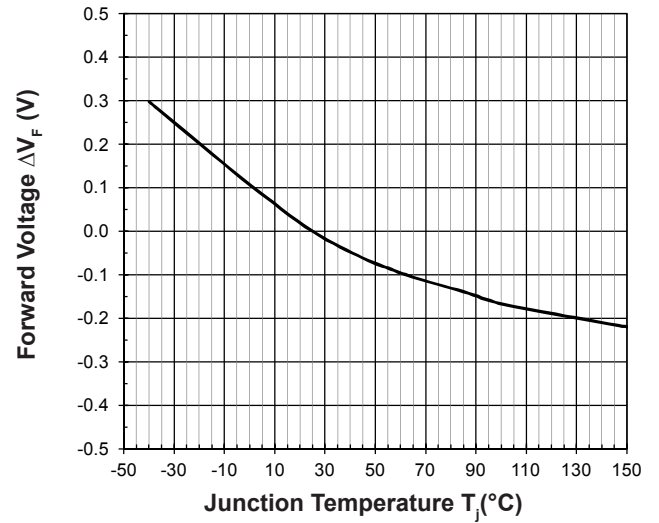
Wavelength Shift Vs Forward Current

$$\lambda_{\text{dom}} = f(I_F); T_j = 25^\circ\text{C}$$



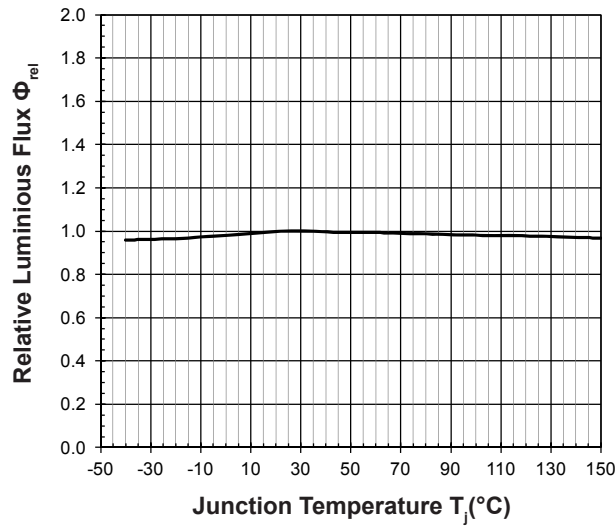
Forward Voltage Vs Junction Temperature

$$\Delta V_F = V_F - V_F(25^\circ\text{C}) = f(T_j); I_F = 150\text{mA}$$



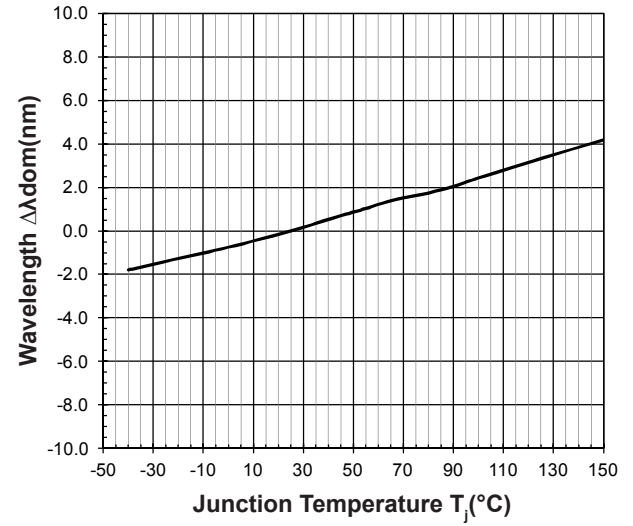
Relative Luminous Flux Vs Junction Temperature

$$\Phi_V/\Phi_V(25^\circ\text{C}) = f(T_j); I_F = 150\text{mA}$$

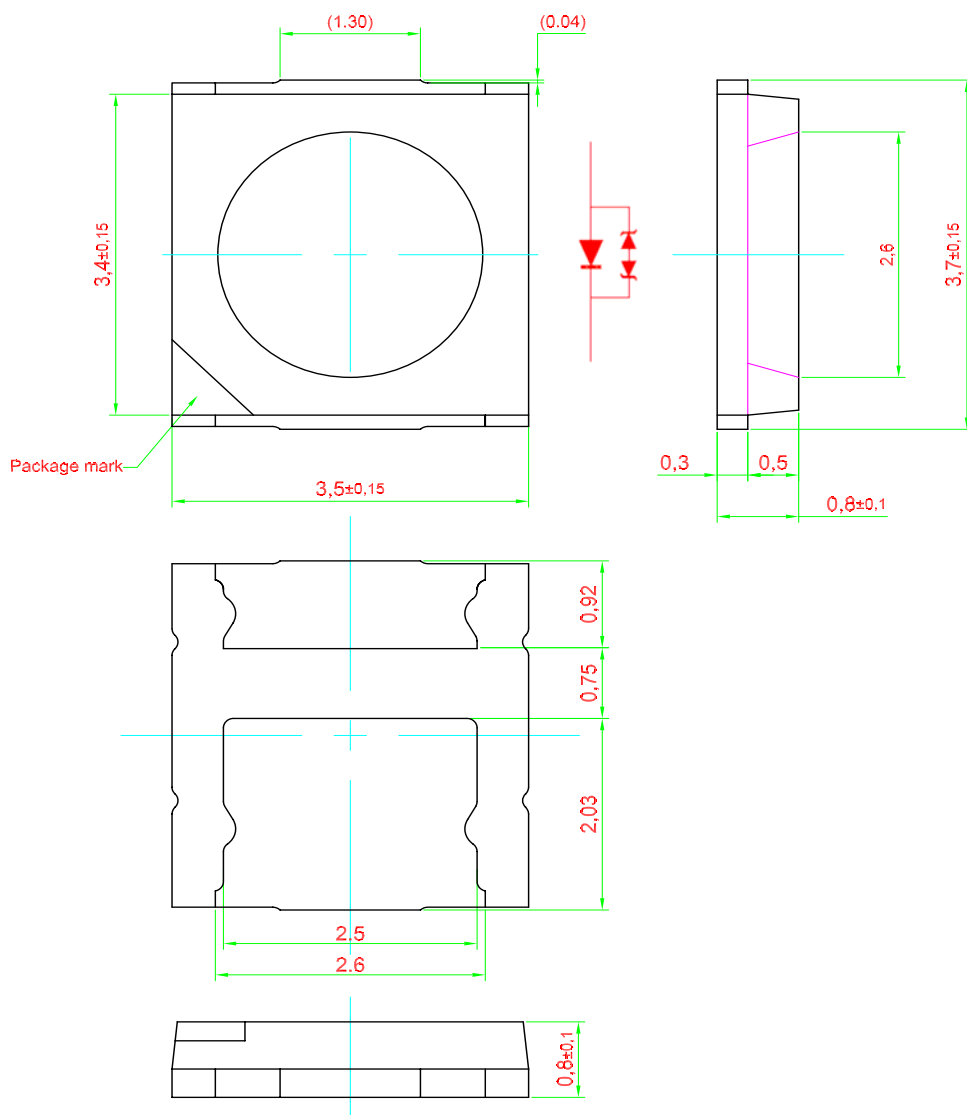


Wavelength Vs Junction Temperature

$$\Delta \lambda_{\text{dom}} = \lambda_{\text{dom}} - \lambda_{\text{dom}}(25^\circ\text{C}) = f(T_j); I_F = 150\text{mA}$$



PrimaxPlus • InGaN: MAB-EZHG Package Outlines



Notes:
 Primary thermal path is through Cathode lead of LED package.
 General tolerance: ± 0.1 mm.

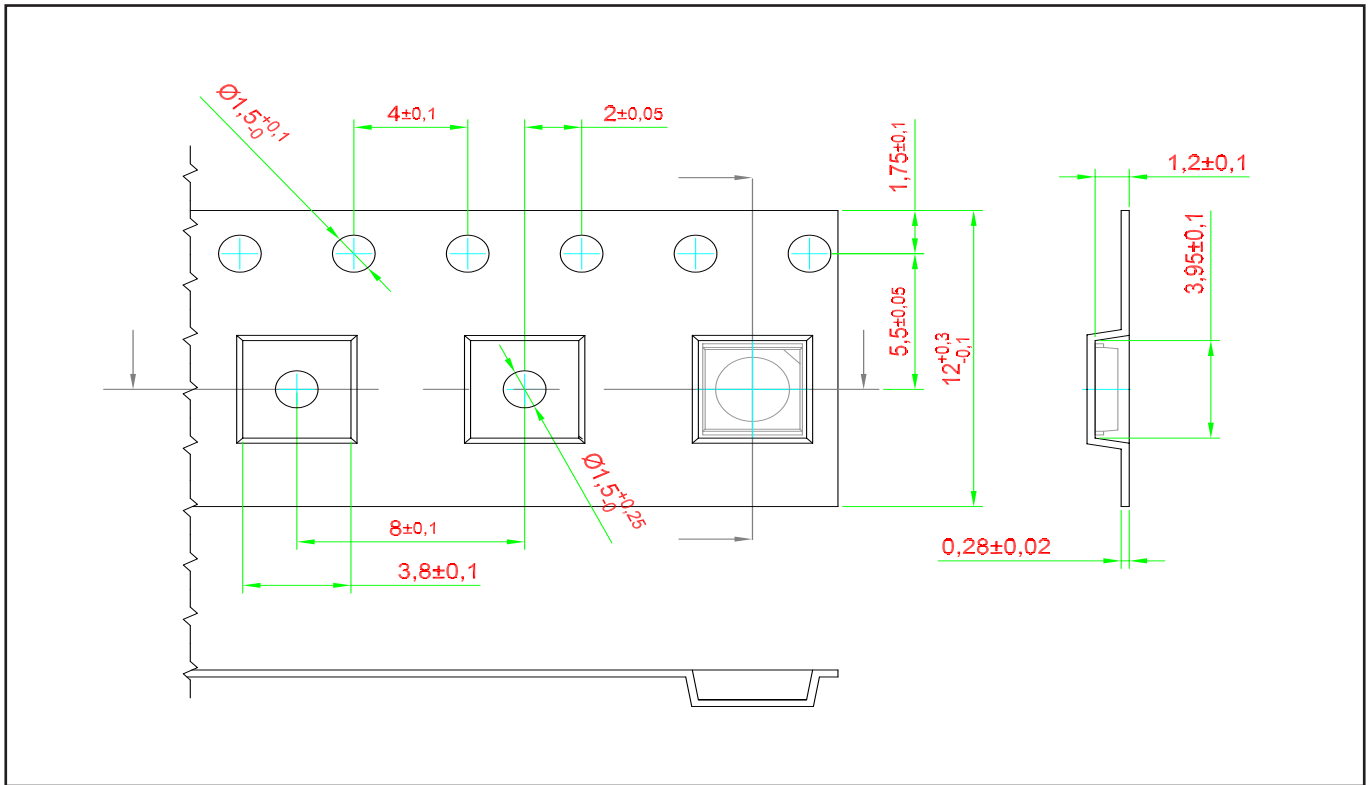
Material

Material	
Lead-frame	Cu Alloy With Au Plating
Package	High Temperature Resistant Plastic
Encapsulant	Silicone Resin
Soldering Leads	Au Plating

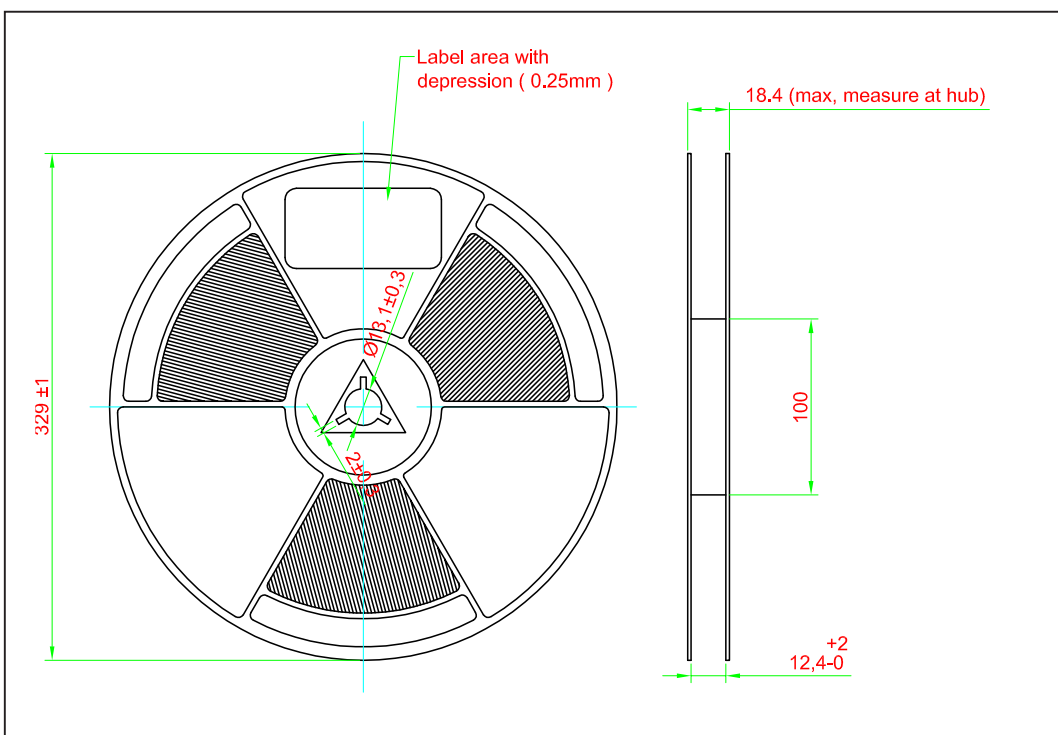
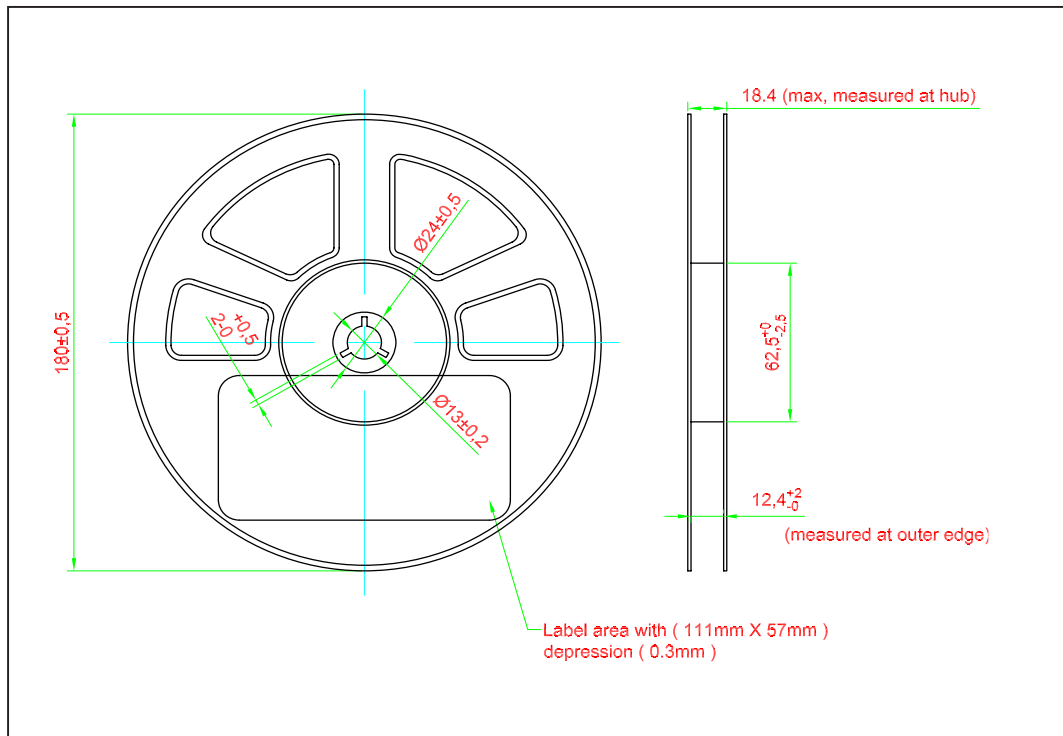
Technical drawing of a stencil pattern for a 1000x1000mm sheet. The drawing includes three views with dimensions in millimeters:

- Top View:** Shows a central rectangular area with dimensions 2.6 (width) and 1.68 (height). The overall width is 2.8 and the overall height is 2.18. A border of 0.23 is indicated on the left side.
- Side View:** Shows a profile with dimensions 1.07 (total height), 0.57 (bottom section), 0.4 (middle section), 0.4 (top section), and 0.65 (total width).
- Recommended Stencil Pattern:** Shows a hatched area with dimensions 2.2 (width) and 1.98 (height). A 0.2 gap is indicated on the right side, and a 0.7 offset is shown on the top edge.

Taping and orientation



Packaging Specification

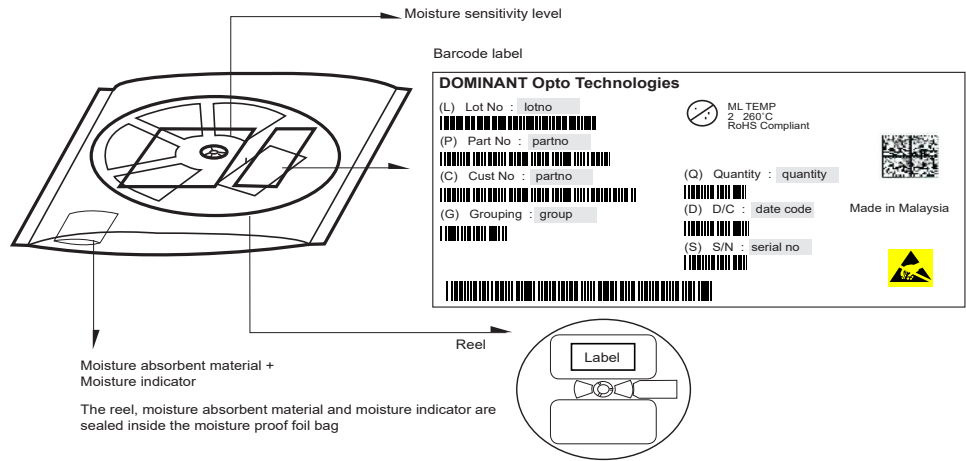


	Reel Diameter (mm)	Quantity (pcs)	*Ordering Number
Standard Packing	180	1000	MAB-EZHG-xxx-x
Optional Packing	329	5000	MAB-EZHG-xxx-x-5

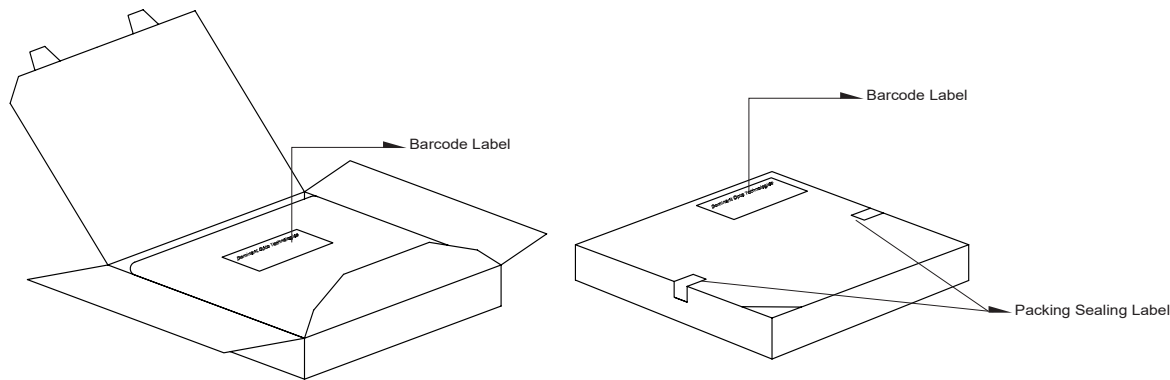
Notes:

* For ordering purpose only. Please consult sales and marketing for details.

Packaging Specification



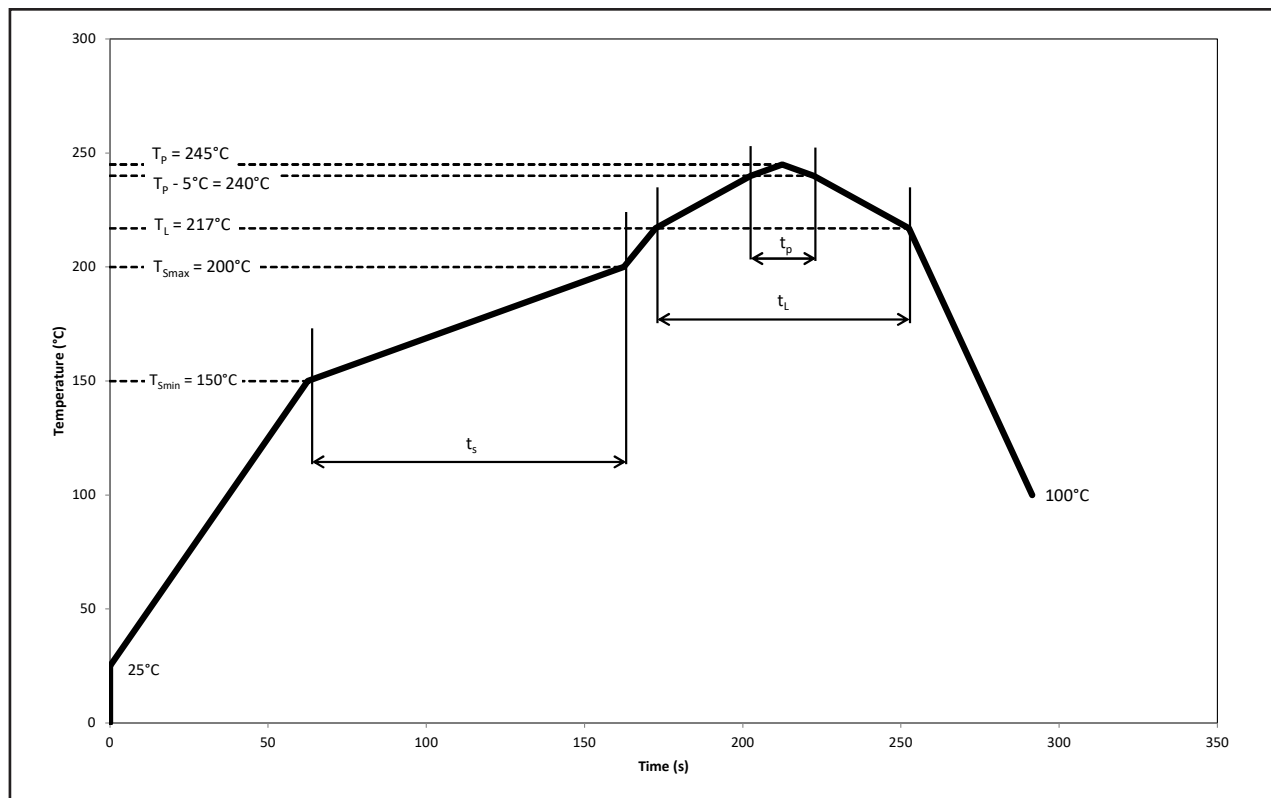
Quantity per bag (pcs)	Average 1pc PrimaxPlus (gram)	1 completed bag (gram)
1000	0.034	230 ± 10
5000	0.034	1150 ± 10



Reel Diameter (mm)	Packing Box Dimensions (mm)
180	210 x 210 x 20
329	345 x 345 x 20

Recommended Pb-free Soldering Profile

Product complies to MSL Level 2 acc. to JEDEC J-STD-020E



Profile Feature	Symbol	Min.	Pb-Free Assembly		Unit
			Recommended	Max.	
Ramp-up rate to preheat 25°C to T_{smin}	-	-	2	3	°C/s
Time t_s T_{smin} to T_{smax}	t_s	60	100	120	s
Ramp-up rate to peak T_L to T_p	-	-	2	3	°C/s
Liquidous temperature	T_L	-	217	-	°C
Time above liquidous temperature	t_L	60	80	150	s
Peak temperature	T_p	-	245	260	°C
Time within 5°C of the specified peak temperature $T_p - 5^{\circ}\text{C}$	t_p	10	20	30	s
Ramp-down rate T_p to 100°C	-	-	3	6	°C/s
Time 25°C to T_p	-	-	-	480	s

Appendix

1) **Brightness:**

- 1.1 Luminous intensity is measured at current pulse 25 ms(typ) with an internal reproducibility of $\pm 8 \%$ and an expanded uncertainty of $\pm 11 \%$ (according to GUM with a coverage factor of $k=3$).
- 1.2 Luminous flux is measured at current pulse 25 ms(typ) with an internal reproducibility of $\pm 8 \%$ and an expanded uncertainty of $\pm 11 \%$ (according to GUM with a coverage factor of $k=3$).
- 1.3 Radiant intensity is measured at current pulse 25 ms(typ) with an internal reproducibility of $\pm 8 \%$ and an expanded uncertainty of $\pm 11 \%$ (according to GUM with a coverage factor of $k=3$).
- 1.4 Radiant flux is measured at current pulse 25 ms(typ) with an internal reproducibility of $\pm 8 \%$ and an expanded uncertainty of $\pm 11 \%$ (according to GUM with a coverage factor of $k=3$).

2) **Color:**

- 2.1 Chromaticity coordinate groups are measured at current pulse 25 ms(typ) with an internal reproducibility of ± 0.005 and an expanded uncertainty of ± 0.01 (accordingly to GUM with a coverage factor of $k=3$).
- 2.2 Dominant wavelength is measured at current pulse 25 ms(typ) with an internal reproducibility of $\pm 0.5\text{nm}$ and an expanded uncertainty of $\pm 1\text{nm}$ (accordingly to GUM with a coverage factor of $k=3$).

3) **Voltage:**

- 3.1 Forward Voltage, V_f is measured when a current pulse of 8 ms(typ) with an internal reproducibility of $\pm 0.05\text{V}$ and an expanded uncertainty of $\pm 0.1\text{V}$ (accordingly to GUM with a coverage factor of $k=3$).

4) **Typical Values:**

- 4.1 At special conditions of LED manufacturing processes, typical data or calculated correlations of technical parameters only reflect the statistical figures. But not necessarily correspond to the actual parameters of each single product, which could differ from the typical data or calculated correlations or the typical characteristic line. These typical data may change whenever technical improvements happen.

5) **Tolerance of Measure**

- 5.1 Unless otherwise noted in drawing, tolerances are specified with ± 0.1 and dimension are specified in mm.

Revision History

Page	Subjects	Date of Modification
-	Initial Release	05 Mar 2019
2, 4, 5	Add New Partno: MAB-EZHG-H3K2-2, MAB-EZHG-JK3-3 Not for New Design: MAB-EZHG-HK2-1 Update Graph: Relative Luminous Flux Vs Forward Current; Forward Current Vs Forward Voltage & Relative Wavelength Shift Vs Forward Current	14 Jul 2020
9, 10, 11	Update Packaging Specification Update Recommended Pb-free Soldering Profile	21 Mar 2022
2	Not for New Design: MAB-EZHG-H3K2-2, MAB-EZHG-JK3-3	03 Apr 2023

NOTE

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